



**TRANSMITTAL LETTER**  
**(General - Patent Pending)**

Docket No.  
E0520CIP

Inventor Application Of: **Kashmir S. Sahota, Diana M. Schonauer, Johannes F. Groschopf, Gerd F.C. Marxsen, Steven A. Avanzino**

Serial No.	Filing Date	Examiner	Group Art Unit
09/749,191	December 26, 2000	L. Umez-Eronini	1765

Title: **"PREVENTION OF PRECIPITATION DEFECTS ON COPPER INTERCONNECTS DURING CMP BY USE OF SOLUTIONS CONTAINING ORGANIC COMPOUNDS WITH SILICA ADSORPTION AND COPPER CORROSION INHIBITING PROPERTIES"**

TO THE ASSISTANT COMMISSIONER FOR PATENTS:

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**Response to Office Action (5 pp)**  
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in the above identified application.

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I certify that this document and fee is being deposited on **March 18, 2003** with the U.S. Postal Service as first class mail under 37 C.F.R. 1.8 and is addressed to the Assistant Commissioner for Patents, Washington, D.C. 20231.

  
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